

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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| In re application of: | § | Attorney Docket No. |
| Hsien-Wei Chen, et al. | § | 2003-1410 / 24061.193 |
| Serial No.: 10/801,475 | § | Customer No. 42717 |
| Filed: March 16, 2004 | § | Group Art Unit: 2822 |
| For: SYSTEM FOR HEAT | § | Examiner: Monica Lewis |
| DISSIPATION IN | § | |
| SEMICONDUCTOR DEVICES | § | Confirmation No.: 1783 |
| | § | Notice of Allowance: 01-02-2008 |

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Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

I hereby certify that this correspondence (including any listed enclosures) is being electronically filed in the United States Patent and Trademark Office via the EFS-Web system on January 17, 2008.



Linda Ingram

AMENDMENT UNDER 37 CFR §1.312

On January 2, 2008, the Patent Office issued a Notice of Allowance, accompanied by a Notice of Allowability that includes a drawing objection, and a requirement for a corrected drawing. This paper is being submitted to document a telephone interview with the Examiner, and to resolve the drawing objection.